

WASHINGTON INTERNSHIPS FOR STUDENTS OF ENGINEERING

**2019 Summer Program
(2 June – 3 August 2019)**

Application Instructions

Applicant must be (1) a Junior or Senior engineering student (must have physically attended a university or college at least 6 semesters or equivalent, if schools has quarter system) or a recent engineering graduate beginning study in a graduate-level, technology policy-related program; (2) a citizen or legal permanent resident of the United States; and (3) a student (or higher grade) member of IEEE, Inc.

Only completed applications will be considered. A complete application includes the following:

- (1) A completed application form (two pages and **TWO** attached essay(s));
- (2) A copy of your transcript(s); Official transcript required
- (3) **ONE** letter of reference from a college professor
- (4) A college writing sample

Submit your application by mail or email to:

IEEE-USA
Attn: Diana Librizzi
2001 L Street NW, Suite 700
Washington, DC 20036
Tel: (202) 530-8354
Email: d.librizzi@ieee.org

Deadline: All materials must be postmarked by 31 December 2018

For more information, visit the WISE Home Page at:



<http://www.wise-intern.org>





**APPLICATION FOR WASHINGTON INTERNSHIPS
FOR STUDENTS OF ENGINEERING (WISE)
(Please type or print in black ink)**

Name _____

College Address _____

Home Address _____

Home Telephone _____ College Telephone _____

Emergency Contact Name & Phone Number _____

Social Security Number - For purposes of arranging meetings in some federal facilities, this information needs to be provided. If selected as an IEEE WISE Intern, you will be required to provide this by April 1, 2019.

Citizenship _____ Date of Birth _____

E-Mail Address _____

University in which enrolled _____

Expected date of graduation _____

Major/Minor _____

Special areas of interest _____

GPA (overall) _____ GPA (major field) _____

IEEE Student Member # _____

How did you find out about the WISE Program? _____

Indicate two persons from whom references were requested:

Name _____

Professional Address _____

Telephone _____

Email _____

Name _____

Professional Address _____

Telephone _____

[Type here]

Email _____

WISE APPLICATION FORM (Cont'd)

List any IEEE student office(s) held (with years) along with any IEEE student or other extra-curricular activities in which you have participated in the last three-four years:

APPLICATION ESSAYS

Prepare and attach two short essays on the following topics. Each essay should be approximately 500 words (one page), single spaced, with 12-point type.

Essay 1: Why should engineers be concerned about public policy issues and what can they contribute to the process?

Essay 2: What specific technology-related public policy issue would you like to explore during the 9-week program and why? The policy issue should be related to either automotive or aerospace issues.

There are no right or wrong answers. The essays are reviewed primarily as samples of your writing. They also help your sponsoring societies better understand your interests and your grasp of policy issues. If chosen for the WISE program, your answer to question (2) does not constitute a topic selection; topics will be finalized after consultation with your sponsoring society.



**REFERENCE
INFORMATION**

REQUEST

Each summer the WISE program brings undergraduate engineering students to Washington, D.C. to learn more about the relationship between government and the technical community. Interns attend 25-30 meetings with policy makers and complete a topic paper on a specific engineering-public policy issue of interest to both the student and the sponsoring organization. As part of the selection process, each applicant is requested to have two references to be included in his/her file.

Name of Applicant _____

Last

First

Name of Reference _____

Last

First

Title _____

Department _____

Address _____

1. NARRATIVE COMMENTS: (Please type or print in black ink. Attach additional pages if desired.).



(OVER)

2. QUALIFICATIONS: I would compare this student with others on a peer level as follows:

a. QUALITY OF ACADEMIC WORK

EXCELLENT	GOOD	FAIR	POOR
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b. COMMUNICATION SKILLS (ORAL):

EXCELLENT	GOOD	FAIR	POOR
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c. COMMUNICATION SKILLS (WRITTEN):

EXCELLENT	GOOD	FAIR	POOR
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d. INTERPERSONAL SKILLS:

EXCELLENT	GOOD	FAIR	POOR
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e. LEADERSHIP ABILITIES:

EXCELLENT	GOOD	FAIR	POOR
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f. MOTIVATION:

EXCELLENT	GOOD	FAIR	POOR
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g. MATURITY:

EXCELLENT	GOOD	FAIR	POOR
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STATEMENT OF CONFIDENTIALITY

My preparation of this reference is conditioned on the promise of WISE to hold my identity as author of these comments in confidence.

My preparation of this reference is NOT conditioned on the promise of WISE to hold my identity as author of these comments in confidence.

Signature of Respondent _____ Date _____

RETURN COMPLETED REFERENCE TO:

IEEE-USA
Attn: Diana Librizzi
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Washington, DC 20036
Tel: (202) 530-8354
Email: d.librizzi@ieee.org

APPLICATION DEADLINE

ALL APPLICATION MATERIALS MUST BE POSTMARKED BY 31 December 2018
